

# HEF4049B-Q100

## Hex inverting buffers

Rev. 2 — 10 September 2014

Product data sheet

## 1. General description

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The HEF4049B-Q100 provides six inverting buffers with high current output capability suitable for driving TTL or high capacitive loads. Since input voltages in excess of the supply voltage of the buffers are permitted, the buffers may also be used to convert logic levels of up to 15 V to standard TTL levels. Their guaranteed fan-out into common bipolar logic elements is shown in [Table 3](#).

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$  (usually ground). Unused inputs must be connected to  $V_{DD}$ ,  $V_{SS}$ , or another input.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

## 2. Features and benefits

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- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
  - ◆ Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$
- Accepts input voltages in excess of the supply voltage
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V ( $C = 200\text{ pF}$ ,  $R = 0\text{ }\Omega$ )
- Complies with JEDEC standard JESD 13-B

## 3. Applications

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- Industrial
- LOCMOS (Local Oxidation CMOS) to DTL/TTL converter
- HIGH sink current for driving two TTL loads
- HIGH-to-LOW level logic conversion



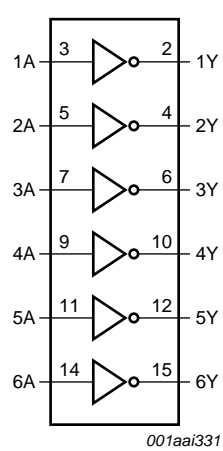
## 4. Ordering information

**Table 1. Ordering information**

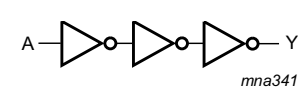
All types operate from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ .

| Type number    | Package |  | Version  |
|----------------|---------|--|----------|
|                | Name    | Description  |          |
| HEF4049BT-Q100 | SO16    | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |

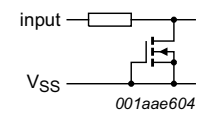
## 5. Functional diagram



**Fig 1. Logic symbol**



**Fig 2. Logic diagram for one gate**

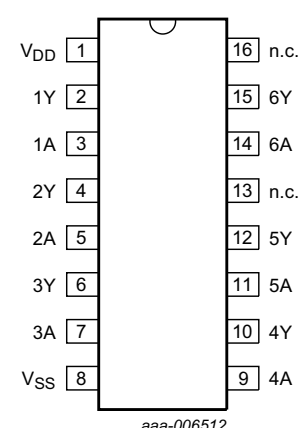


**Fig 3. Input protection circuit**

## 6. Pinning information

### 6.1 Pinning

**HEF4049B-Q100**



**Fig 4. Pin configuration**

## 6.2 Pin description

Table 2. Pin description

| Symbol          | Pin                 | Description           |
|-----------------|---------------------|-----------------------|
| V <sub>DD</sub> | 1                   | supply voltage        |
| 1Y to 6Y        | 2, 4, 6, 10, 12, 15 | output                |
| 1A to 6A        | 3, 5, 7, 9, 11, 14  | input                 |
| V <sub>SS</sub> | 8                   | ground supply voltage |
| n.c.            | 13, 16              | not connected         |

## 7. Functional description

Table 3. Guaranteed fan-out

| Driven element | Guaranteed fan-out |
|----------------|--------------------|
| Standard TTL   | 2                  |
| 74 LS          | 9                  |
| 74 L           | 16                 |

## 8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter               | Conditions  | Min  | Max                   | Unit |
|------------------|-------------------------|---|------|-----------------------|------|
| V <sub>DD</sub>  | supply voltage          |   | -0.5 | +18                   | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V or V <sub>I</sub> > V <sub>DD</sub> + 0.5 V | -    | ±10                   | mA   |
| V <sub>I</sub>   | input voltage           |   | -0.5 | V <sub>DD</sub> + 0.5 | V    |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < -0.5 V or V <sub>O</sub> > V <sub>DD</sub> + 0.5 V | -    | ±10                   | mA   |
| I <sub>I/O</sub> | input/output current    |   | -    | ±10                   | mA   |
| I <sub>DD</sub>  | supply current          |   | -    | 50                    | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65  | +150                  | °C   |
| T <sub>amb</sub> | ambient temperature     |   | -40  | +85                   | °C   |
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> -40 °C to +85 °C                                   | [1]  | 500                   | mW   |
| P                | power dissipation       | per output  | -    | 100                   | mW   |

[1] For SO16 package: P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.

## 9. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol           | Parameter           | Conditions  | Min | Typ | Max             | Unit |
|------------------|---------------------|-------------|-----|-----|-----------------|------|
| V <sub>DD</sub>  | supply voltage      |             | 3   | -   | 15              | V    |
| V <sub>I</sub>   | input voltage       |             | 0   | -   | V <sub>DD</sub> | V    |
| T <sub>amb</sub> | ambient temperature | in free air | -40 | -   | +85             | °C   |

Table 5. Recommended operating conditions ...continued

| Symbol              | Parameter                           | Conditions             | Min | Typ | Max  | Unit            |
|---------------------|-------------------------------------|------------------------|-----|-----|------|-----------------|
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{DD} = 5\text{ V}$  | -   | -   | 3.75 | $\mu\text{s/V}$ |
|                     |                                     | $V_{DD} = 10\text{ V}$ | -   | -   | 0.5  | $\mu\text{s/V}$ |
|                     |                                     | $V_{DD} = 15\text{ V}$ | -   | -   | 0.08 | $\mu\text{s/V}$ |

## 10. Static characteristics

Table 6. Static characteristics

$V_{SS} = 0\text{ V}$ ;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

| Symbol   | Parameter                 | Conditions                     | $V_{DD}$ | $T_{amb} = -40\text{ }^\circ\text{C}$ |           | $T_{amb} = 25\text{ }^\circ\text{C}$ |           | $T_{amb} = 85\text{ }^\circ\text{C}$ |           | Unit          |
|----------|---------------------------|--------------------------------|----------|---------------------------------------|-----------|--------------------------------------|-----------|--------------------------------------|-----------|---------------|
|          |                           |                                |          | Min                                   | Max       | Min                                  | Max       | Min                                  | Max       |               |
| $V_{IH}$ | HIGH-level input voltage  | $ I_O  < 1\text{ }\mu\text{A}$ | 5 V      | 3.5                                   | -         | 3.5                                  | -         | 3.5                                  | -         | V             |
|          |                           |                                | 10 V     | 7.0                                   | -         | 7.0                                  | -         | 7.0                                  | -         | V             |
|          |                           |                                | 15 V     | 11.0                                  | -         | 11.0                                 | -         | 11.0                                 | -         | V             |
| $V_{IL}$ | LOW-level input voltage   | $ I_O  < 1\text{ }\mu\text{A}$ | 5 V      | -                                     | 1.5       | -                                    | 1.5       | -                                    | 1.5       | V             |
|          |                           |                                | 10 V     | -                                     | 3.0       | -                                    | 3.0       | -                                    | 3.0       | V             |
|          |                           |                                | 15 V     | -                                     | 4.0       | -                                    | 4.0       | -                                    | 4.0       | V             |
| $V_{OH}$ | HIGH-level output voltage | $ I_O  < 1\text{ }\mu\text{A}$ | 5 V      | 4.95                                  | -         | 4.95                                 | -         | 4.95                                 | -         | V             |
|          |                           |                                | 10 V     | 9.95                                  | -         | 9.95                                 | -         | 9.95                                 | -         | V             |
|          |                           |                                | 15 V     | 14.95                                 | -         | 14.95                                | -         | 14.95                                | -         | V             |
| $V_{OL}$ | LOW-level output voltage  | $ I_O  < 1\text{ }\mu\text{A}$ | 5 V      | -                                     | 0.05      | -                                    | 0.05      | -                                    | 0.05      | V             |
|          |                           |                                | 10 V     | -                                     | 0.05      | -                                    | 0.05      | -                                    | 0.05      | V             |
|          |                           |                                | 15 V     | -                                     | 0.05      | -                                    | 0.05      | -                                    | 0.05      | V             |
| $I_{OH}$ | HIGH-level output current | $V_O = 2.5\text{ V}$           | 5 V      | -1.7                                  | -         | -1.4                                 | -         | -1.1                                 | -         | mA            |
|          |                           | $V_O = 4.6\text{ V}$           | 5 V      | -0.52                                 | -         | -0.44                                | -         | -0.36                                | -         | mA            |
|          |                           | $V_O = 9.5\text{ V}$           | 10 V     | -1.3                                  | -         | -1.1                                 | -         | -0.9                                 | -         | mA            |
|          |                           | $V_O = 13.5\text{ V}$          | 15 V     | -3.6                                  | -         | -3.0                                 | -         | -2.4                                 | -         | mA            |
| $I_{OL}$ | LOW-level output current  | $V_O = 0.4\text{ V}$           | 4.75 V   | 3.5                                   | -         | 2.9                                  | -         | 2.3                                  | -         | mA            |
|          |                           | $V_O = 0.5\text{ V}$           | 10 V     | 12.0                                  | -         | 10.0                                 | -         | 8.0                                  | -         | mA            |
|          |                           | $V_O = 1.5\text{ V}$           | 15 V     | 24.0                                  | -         | 20.0                                 | -         | 16.0                                 | -         | mA            |
| $I_I$    | input leakage current     | $V_{DD} = 15\text{ V}$         | 15 V     | -                                     | $\pm 0.3$ | -                                    | $\pm 0.3$ | -                                    | $\pm 1.0$ | $\mu\text{A}$ |
| $I_{DD}$ | supply current            | $I_O = 0\text{ A}$             | 5 V      | -                                     | 4.0       | -                                    | 4.0       | -                                    | 30        | $\mu\text{A}$ |
|          |                           |                                | 10 V     | -                                     | 8.0       | -                                    | 8.0       | -                                    | 60        | $\mu\text{A}$ |
|          |                           |                                | 15 V     | -                                     | 16.0      | -                                    | 16.0      | -                                    | 120       | $\mu\text{A}$ |
| $C_I$    | input capacitance         |                                |          | -                                     | -         | -                                    | 7.5       | -                                    | -         | pF            |

## 11. Dynamic characteristics

**Table 7. Dynamic characteristics**

$V_{SS} = 0\text{ V}$ ;  $C_L = 50\text{ pF}$ ;  $t_r = t_f \leq 20\text{ ns}$ ;  $T_{amb} = 25\text{ °C}$ ; unless otherwise specified.

| Symbol    | Parameter                          | Conditions                                | $V_{DD}$           | Extrapolation formula                   | Min | Typ | Max | Unit |
|-----------|------------------------------------|---|--------------------|---|-----|-----|-----|------|
| $t_{PHL}$ | HIGH to LOW propagation delay      | nA to nY;<br>see <a href="#">Figure 5</a> | 5 V <sup>[1]</sup> | $26\text{ ns} + (0.18\text{ ns/pF})C_L$ | -   | 35  | 70  | ns   |
|           |                                    |   | 10 V               | $11\text{ ns} + (0.08\text{ ns/pF})C_L$ | -   | 15  | 30  | ns   |
|           |                                    |   | 15 V               | $9\text{ ns} + (0.05\text{ ns/pF})C_L$  | -   | 12  | 25  | ns   |
| $t_{PLH}$ | LOW to HIGH propagation delay      | nA to nY;<br>see <a href="#">Figure 5</a> | 5 V <sup>[1]</sup> | $23\text{ ns} + (0.55\text{ ns/pF})C_L$ | -   | 50  | 100 | ns   |
|           |                                    |   | 10 V               | $14\text{ ns} + (0.23\text{ ns/pF})C_L$ | -   | 25  | 50  | ns   |
|           |                                    |   | 15 V               | $12\text{ ns} + (0.16\text{ ns/pF})C_L$ | -   | 20  | 40  | ns   |
| $t_{THL}$ | HIGH to LOW output transition time | see <a href="#">Figure 5</a>              | 5 V <sup>[1]</sup> | $3\text{ ns} + (0.35\text{ ns/pF})C_L$  | -   | 20  | 40  | ns   |
|           |                                    |   | 10 V               | $3\text{ ns} + (0.14\text{ ns/pF})C_L$  | -   | 10  | 20  | ns   |
|           |                                    |   | 15 V               | $2\text{ ns} + (0.09\text{ ns/pF})C_L$  | -   | 7   | 14  | ns   |
| $t_{TLH}$ | LOW to HIGH output transition time | see <a href="#">Figure 5</a>              | 5 V <sup>[1]</sup> | $10\text{ ns} + (1.00\text{ ns/pF})C_L$ | -   | 60  | 120 | ns   |
|           |                                    |   | 10 V               | $9\text{ ns} + (0.42\text{ ns/pF})C_L$  | -   | 30  | 60  | ns   |
|           |                                    |   | 15 V               | $6\text{ ns} + (0.28\text{ ns/pF})C_L$  | -   | 20  | 40  | ns   |

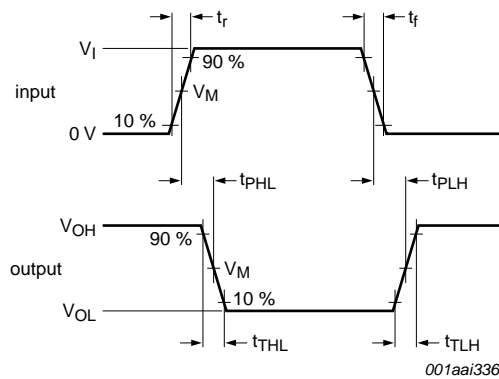
[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown ( $C_L$  in pF).

**Table 8. Dynamic power dissipation  $P_D$**

$P_D$  can be calculated from the formulas shown.  $V_{SS} = 0\text{ V}$ ;  $t_r = t_f \leq 20\text{ ns}$ ;  $T_{amb} = 25\text{ °C}$ .

| Symbol | Parameter                 | $V_{DD}$ | Typical formula for $P_D$ ( $\mu\text{W}$ )                       | where:   |
|--------|---------------------------|----------|---|--|
| $P_D$  | dynamic power dissipation | 5 V      | $P_D = 2500 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$  | $f_i$ = input frequency in MHz;<br>$f_o$ = output frequency in MHz;<br>$C_L$ = output load capacitance in pF;<br>$V_{DD}$ = supply voltage in V;<br>$\Sigma(f_o \times C_L)$ = sum of the outputs. |
|        |                           | 10 V     | $P_D = 11000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ |  |
|        |                           | 15 V     | $P_D = 35000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ |  |

12. Waveforms

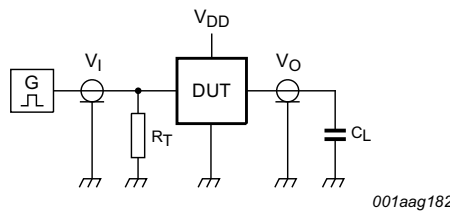


Measurement points are given in [Table 9](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 5. Input (nA) to output (nY) propagation delays and transition times

Table 9. Measurement points

| Input       |                 | Output      |             |             |
|-------------|-----------------|-------------|-------------|-------------|
| $V_M$       | $V_I$           | $V_M$       | $V_X$       | $V_Y$       |
| $0.5V_{DD}$ | 0 V to $V_{DD}$ | $0.5V_{DD}$ | $0.1V_{DD}$ | $0.9V_{DD}$ |



Test data is given in [Table 10](#).  
 Definitions for test circuit:  
 $C_L$  = Load capacitance including jig and probe capacitance.  
 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

Fig 6. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage | Input    |          |              | Load  |
|----------------|----------|----------|--------------|-------|
|                | $V_I$    | $V_M$    | $t_r, t_f$   | $C_L$ |
| 5 V to 15 V    | $V_{DD}$ | $0.5V_I$ | $\leq 20$ ns | 50 pF |

13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

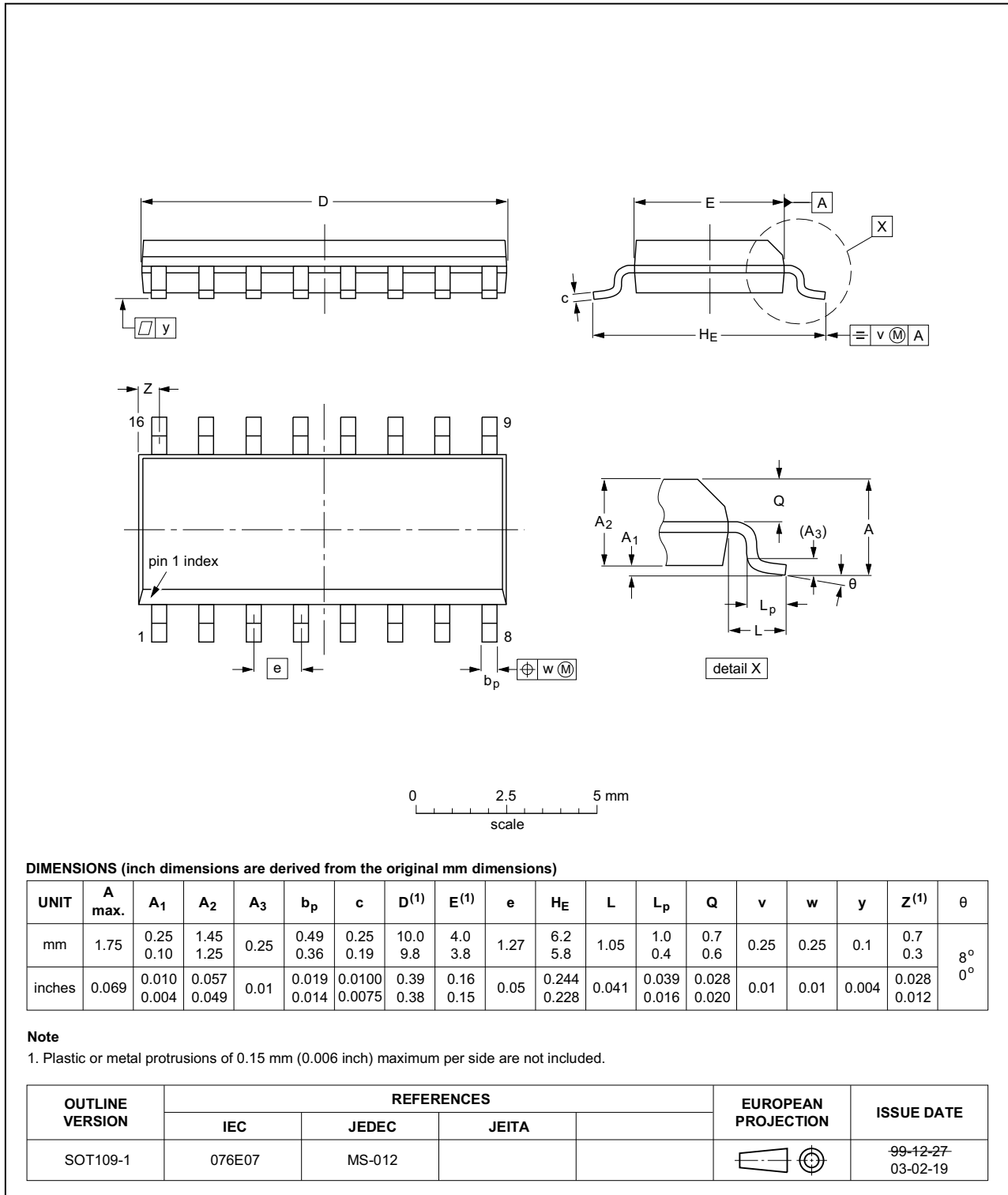


Fig 7. Package outline SOT109-1 (SO16)

## 14. Abbreviations

Table 11. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| DTL     | Diode Transistor Logic      |
| LOC MOS | Local Oxidation CMOS        |
| TTL     | Transistor Transistor Logic |
| HBM     | Human Body Model            |
| ESD     | ElectroStatic Discharge     |
| MM      | Machine Model               |
| MIL     | Military                    |

## 15. Revision history

Table 12. Revision history

| Document ID       | Release date   | Data sheet status  | Change notice | Supersedes        |
|-------------------|--|--------------------|---------------|-------------------|
| HEF4049B_Q100 v.2 | 20140910   | Product data sheet | -             | HEF4049B_Q100 v.1 |
| Modifications:    | <ul style="list-style-type: none"> <li><a href="#">Section 2</a>: ESD protection: MIL-STD-833 changed to MIL-STD883</li> </ul> |                    |               |                   |
| HEF4049B_Q100 v.1 | 20130228   | Product data sheet | -             | -                 |



## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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